

74VCX32500

Low Voltage 36-Bit Universal Bus Transceivers with 3.6V Tolerant Inputs and Outputs

General Description

The VCX32500 is an 36-bit universal bus transceiver which combines D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is HIGH. When LEAB is LOW, the A data is latched if CLKAB is held at a HIGH or LOW logic level. If LEAB is LOW, the A bus data is stored in the latch/flip-flop on the HIGH-to-LOW transition of CLKAB. When OEAB is HIGH, the outputs are active. When OEAB is LOW, the outputs are in a high-impedance state.

Data flow for B to A is similar to that of A to B but uses OEBA, LEBA, and CLKBA. The output enables are complementary (OEAB is active HIGH and OEBA is active LOW).

The VCX32500 is designed for low voltage (1.4V to 3.6V) V_{CC} applications with I/O capability up to 3.6V.

The 74VCX32500 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

Features

- 1.4V to 3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- t_{PD} (A to B, B to A)
 - 2.9 ns max for 3.0V to 3.6V V_{CC}
- Power-down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- Static Drive (I_{OH}/I_{OL})
 - ± 24 mA @ 3.0V V_{CC}
- Uses patented noise/EMI reduction circuitry
- Latchup performance exceeds 300 mA
- ESD performance:
 - Human body model > 2000V
 - Machine model >200V
- Packaged in plastic Fine-Pitch Ball Grid Array (FBGA)

Note 1: To ensure the high-impedance state during power up or power down, OEBA should be tied to V_{CC} through a pull-up resistor and OEAB should be tied to GND through a pull-down resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

Ordering Code:

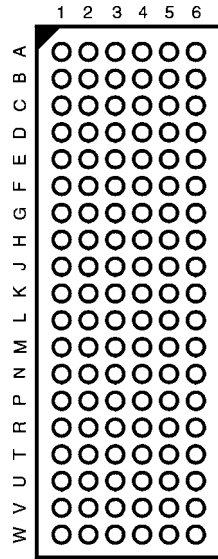
| Order Number | Package Number | Package Description |
|---------------------------------|----------------|--|
| 74VCX32500G (Note 2)(Note 3) | BGA114A | 114-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide |

Note 2: Ordering Code "G" indicates Trays.

Note 3: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

74VCX32500 Low Voltage 36-Bit Universal Bus Transceivers with 3.6V Tolerant Inputs and Outputs

Connection Diagram



(Top Thru View)

Pin Descriptions

| Pin Names | Description |
|--|--|
| OEAB _n | Output Enable Input for A to B Direction (Active HIGH) |
| $\overline{\text{OEBA}}_n$ | Output Enable Input for B to A Direction (Active LOW) |
| LEAB _n , LEBA _n | Latch Enable Inputs |
| $\overline{\text{CLKAB}}_n$, $\overline{\text{CLKBA}}_n$ | Clock Inputs |
| 1A ₁ –1A ₁₈ 2A ₁ –2A ₁₈ | Side A Inputs or 3-STATE Outputs |
| 1B ₁ –1B ₁₈ 2B ₁ –2B ₁₈ | Side B Inputs or 3-STATE Outputs |

FBGA Pin Assignments

| | 1 | 2 | 3 | 4 | 5 | 6 |
|---|------------------|-------------------|----------------------------|-----------------------------|-----------------------------|------------------|
| A | 1A ₂ | 1A ₁ | LEAB ₁ | $\overline{\text{CLKAB}}_1$ | 1B ₁ | 1B ₂ |
| B | 1A ₄ | 1A ₃ | OEAB ₁ | GND | 1B ₃ | 1B ₄ |
| C | 1A ₆ | 1A ₅ | GND | GND | 1B ₅ | 1B ₆ |
| D | 1A ₈ | 1A ₇ | V _{CC} | V _{CC} | 1B ₇ | 1B ₈ |
| E | 1A ₁₀ | 1A ₉ | GND | GND | 1B ₉ | 1B ₁₀ |
| F | 1A ₁₂ | 1A ₁₁ | GND | GND | 1B ₁₁ | 1B ₁₂ |
| G | 1A ₁₄ | 1A ₁₃ | V _{CC} | V _{CC} | 1B ₁₃ | 1B ₁₄ |
| H | 1A ₁₅ | 1A ₁₆ | GND | GND | 1B ₁₆ | 1B ₁₅ |
| J | 1A ₁₇ | 1A ₁₈ | $\overline{\text{OEBA}}_1$ | $\overline{\text{CLKBA}}_1$ | 1B ₁₈ | 1B ₁₇ |
| K | NC | LEAB ₂ | LEBA ₁ | GND | $\overline{\text{CLKAB}}_2$ | NC |
| L | 2A ₂ | 2A ₁ | OEAB ₂ | GND | 2B ₁ | 2B ₂ |
| M | 2A ₄ | 2A ₃ | GND | GND | 2B ₃ | 2B ₄ |
| N | 2A ₆ | 2A ₅ | V _{CC} | V _{CC} | 2B ₅ | 2B ₆ |
| P | 2A ₈ | 2A ₇ | GND | GND | 2B ₇ | 2B ₈ |
| R | 2A ₁₀ | 2A ₉ | GND | GND | 2B ₉ | 2B ₁₀ |
| T | 2A ₁₂ | 2A ₁₁ | V _{CC} | V _{CC} | 2B ₁₁ | 2B ₁₂ |
| U | 2A ₁₄ | 2A ₁₃ | GND | GND | 2B ₁₃ | 2B ₁₄ |
| V | 2A ₁₅ | 2A ₁₆ | $\overline{\text{OEBA}}_2$ | $\overline{\text{CLKBA}}_2$ | 2B ₁₆ | 2B ₁₅ |
| W | 2A ₁₇ | 2A ₁₈ | LEBA ₂ | GND | 2B ₁₈ | 2B ₁₇ |

Function Table (Note 4)

| Inputs | | | | Outputs |
|-------------------|-------------------|-----------------------------|----------------|-------------------------|
| OEAB _n | LEAB _n | $\overline{\text{CLKAB}}_n$ | A _n | B _n |
| L | X | X | X | Z |
| H | H | X | L | L |
| H | H | X | H | H |
| H | L | ↓ | L | L |
| H | L | ↓ | H | H |
| H | L | H | X | B ₀ (Note 5) |
| H | L | L | X | B ₀ (Note 6) |

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial (HIGH or LOW, inputs may not float)

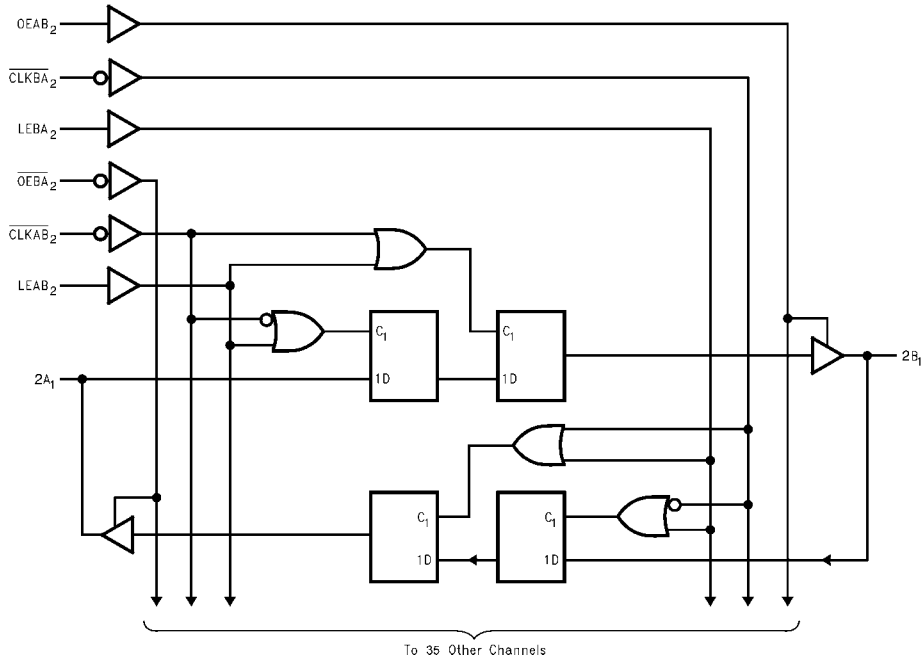
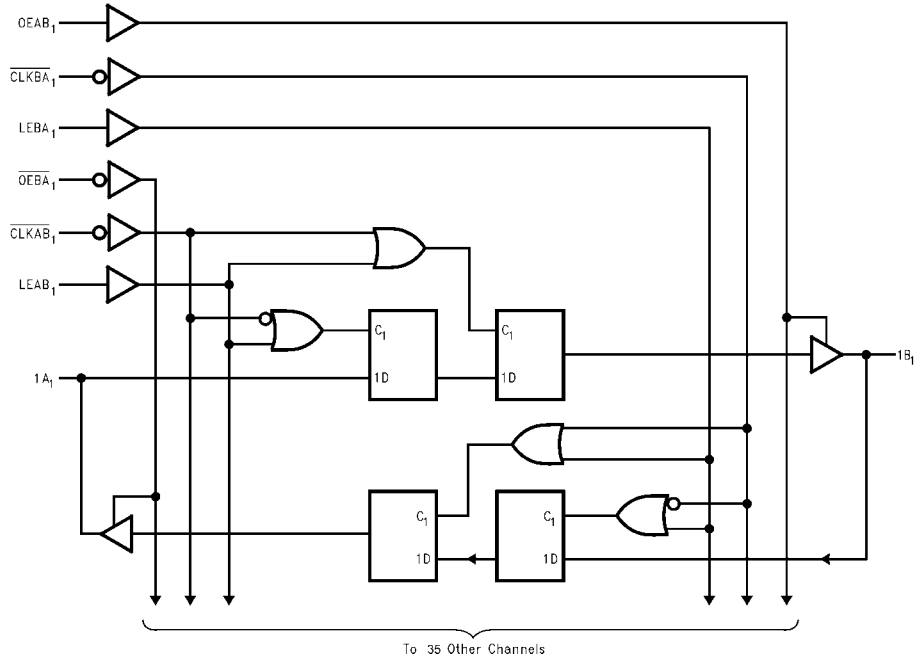
Z = High Impedance

Note 4: A-to-B data flow is shown; B-to-A flow is similar but uses $\overline{\text{OEBA}}$, LEBA and $\overline{\text{CLKBA}}$. OEBA is active LOW.

Note 5: Output level before the indicated steady-state input conditions were established.

Note 6: Output level before the indicated steady-state input conditions were established, provided that CLKAB was LOW before LEAB went LOW.

Logic Diagrams



Absolute Maximum Ratings (Note 7)

| | |
|--|-------------------------|
| Supply Voltage (V_{CC}) | -0.5V to +4.6V |
| DC Input Voltage (V_I) | -0.5V to +4.6V |
| Output Voltage (V_O) | |
| Outputs 3-STATE | -0.5V to +4.6V |
| Outputs Active (Note 8) | -0.5 to $V_{CC} + 0.5V$ |
| DC Input Diode Current (I_{IK}) $V_I < 0V$ | -50 mA |
| DC Output Diode Current (I_{OK}) | |
| $V_O < 0V$ | -50 mA |
| $V_O > V_{CC}$ | +50 mA |
| DC Output Source/Sink Current | |
| (I_{OH}/I_{OL}) | ± 50 mA |
| DC V_{CC} or Ground Current per | |
| Supply Pin (I_{CC} or GND) | ± 100 mA |
| Storage Temperature Range (T_{STG}) | -65°C to +150°C |

Recommended Operating Conditions (Note 9)

| | |
|---|----------------|
| Power Supply | |
| Operating | 1.4V to 3.6V |
| Input Voltage | -0.3V to 3.6V |
| Output Voltage (V_O) | |
| Output in Active States | 0V to V_{CC} |
| Output in 3-STATE | 0V to 3.6V |
| Output Current in I_{OH}/I_{OL} | |
| $V_{CC} = 3.0V$ to 3.6V | ± 24 mA |
| $V_{CC} = 2.3V$ to 2.7V | ± 18 mA |
| $V_{CC} = 1.65V$ to 2.3V | ± 6 mA |
| $V_{CC} = 1.4V$ to 1.6V | ± 2 mA |
| Free Air Operating Temperature (T_A) | -40°C to +85°C |
| Minimum Input Edge Rate ($\Delta t/\Delta V$) | |
| $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$ | 10 ns/V |

Note 7: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The Recommended Operating Conditions tables will define the conditions for actual device operation.

Note 8: I_O Absolute Maximum Rating must be observed.

Note 9: Floating or unused pin (inputs or I/O's) must be held HIGH or LOW.

DC Electrical Characteristics

| Symbol | Parameter | Conditions | V_{CC} (V) | Min | Max | Units |
|--------------------------|---------------------------|---------------------------|-----------------|----------------------|----------------------|-------|
| V_{IH} | HIGH Level Input Voltage | | 2.7 - 3.6 | 2.0 | | V |
| | | | 2.3 - 2.7 | 1.6 | | |
| | | | 1.65 - 2.3 | $0.65 \times V_{CC}$ | | |
| | | | 1.4 - 1.6 | $0.65 \times V_{CC}$ | | |
| V_{IL} | LOW Level Input Voltage | | 2.7 - 3.6 | | 0.8 | V |
| | | | 2.3 - 2.7 | | 0.7 | |
| | | | 1.65 - 2.3 | | $0.35 \times V_{CC}$ | |
| | | | 1.4 - 1.6 | | $0.35 \times V_{CC}$ | |
| V_{OH} | HIGH Level Output Voltage | $I_{OH} = -100 \mu A$ | 2.7 - 3.6 | $V_{CC} - 0.2$ | | V |
| | | | 2.7 | 2.2 | | |
| | | $I_{OH} = -12 \text{ mA}$ | 3.0 | 2.4 | | |
| | | | 3.0 | 2.2 | | |
| | | $I_{OH} = -18 \text{ mA}$ | 2.3 - 2.7 | $V_{CC} - 0.2$ | | |
| | | | 2.3 | 2.0 | | |
| | | $I_{OH} = -6 \text{ mA}$ | 2.3 | 1.8 | | |
| | | | 2.3 | 1.7 | | |
| | | $I_{OH} = -100 \mu A$ | 1.65 - 2.3 | $V_{CC} - 0.2$ | | |
| | | | 1.65 | 1.25 | | |
| $I_{OH} = -100 \mu A$ | 1.4 - 1.6 | $V_{CC} - 0.2$ | | | | |
| | 1.4 | 1.05 | | | | |
| $I_{OH} = -2 \text{ mA}$ | | | | | | |
| | | | | | | |

| DC Electrical Characteristics (Continued) | | | | | | | |
|---|---------------------------------------|---|------------------------|---------------------------------|-------|-------|------------------|
| Symbol | Parameter | Conditions | V _{CC} (V) | Min | Max | Units | |
| V _{OL} | LOW Level Output Voltage | I _{OL} = 100 μA | 2.7 - 3.6 | | 0.2 | V | |
| | | I _{OL} = 12 mA | 2.7 | | 0.4 | | |
| | | I _{OL} = 18 mA | 3.0 | | 0.4 | | |
| | | I _{OL} = 24 mA | 3.0 | | 0.55 | | |
| | | I _{OL} = 100 μA | 2.3 - 2.7 | | 0.2 | | |
| | | I _{OL} = 12 mA | 2.3 | | 0.4 | | |
| | | I _{OL} = 18 mA | 2.3 | | 0.6 | | |
| | | I _{OL} = 100 μA | 1.65 - 2.3 | | 0.2 | | |
| | | I _{OL} = 6 mA | 1.65 | | 0.3 | | |
| | | I _{OL} = 100 μA | 1.4 - 1.6 | | 0.2 | | |
| | | I _{OL} = 2 mA | 1.4 | | 0.35 | | |
| I _I | Input Leakage Current | 0V ≤ V _I ≤ 3.6V | 1.4 - 3.6 | | ±5.0 | μA | |
| I _{OZ} | 3-STATE Output Leakage | 0V ≤ V _O ≤ 3.6V V _I = V _{IH} or V _{IL} | 1.4 - 3.6 | | ±10.0 | μA | |
| I _{OFF} | Power Off Leakage Current | 0V ≤ (V _I , V _O) ≤ 3.6V | 0 | | 10.0 | μA | |
| I _{CC} | Quiescent Supply Current | V _I = V _{CC} or GND | 1.4 - 3.6 | | 40.0 | μA | |
| | | V _{CC} ≤ (V _I , V _O) ≤ 3.6V (Note 10) | 1.4 - 3.6 | | ±40.0 | μA | |
| ΔI _{CC} | Increase in I _{CC} per Input | V _{IH} = V _{CC} - 0.6V | 2.7 - 3.6 | | 750 | μA | |
| Note 10: Outputs disabled or 3-STATE only. | | | | | | | |
| AC Electrical Characteristics (Note 11) | | | | | | | |
| Symbol | Parameter | Conditions | V _{CC} (V) | T _A = -40°C to +85°C | | Units | Figure Number |
| | | | | Min | Max | | |
| t _{MAX} | Setup Time | C _L = 30 pF | 3.3 ± 0.3 | 250 | | MHz | |
| | | | 2.5 ± 0.2 | 200 | | | |
| | | | 1.8 ± 0.15 | 100 | | | |
| | | C _L = 15 pF | 1.5 ± 0.1 | 80.0 | | | |
| t _{PHL} | Propagation Delay | C _L = 30 pF, R _L = 500Ω | 3.3 ± 0.3 | 0.6 | 2.7 | ns | Figures 1, 2 |
| t _{PLH} | Bus-to-Bus | | 2.5 ± 0.2 | 0.8 | 3.5 | | |
| | | | 1.8 ± 0.15 | 1.5 | 7.0 | | |
| | | C _L = 15 pF, R _L = 2kΩ | 1.5 ± 0.1 | 1.0 | 14.0 | | Figures 7, 8 |
| t _{PHL} | Propagation Delay | C _L = 30 pF, R _L = 500Ω | 3.3 ± 0.3 | 0.6 | 4.2 | ns | Figures 1, 2 |
| t _{PLH} | Clock-to-Bus | | 2.5 ± 0.2 | 0.8 | 5.3 | | |
| | | | 1.8 ± 0.15 | 1.5 | 9.8 | | |
| | | C _L = 15 pF, R _L = 500Ω | 1.5 ± 0.1 | 1.0 | 19.6 | | Figures 7, 8 |
| t _{PHL} | Propagation Delay | C _L = 30 pF, R _L = 500Ω | 3.3 ± 0.3 | 0.6 | 3.8 | ns | Figures 1, 2 |
| t _{PLH} | LE-to-Bus | | 2.5 ± 0.2 | 0.8 | 4.9 | | |
| | | | 1.8 ± 0.15 | 1.5 | 9.8 | | |
| | | C _L = 15 pF, R _L = 500Ω | 1.5 ± 0.1 | 1.0 | 19.6 | | Figures 7, 8 |
| t _{PZL} | Output Enable Time | C _L = 30 pF, R _L = 500Ω | 3.3 ± 0.3 | 0.6 | 3.8 | ns | Figures 1, 3, 4 |
| t _{PZH} | | | 2.5 ± 0.2 | 0.8 | 4.9 | | |
| | | | 1.8 ± 0.15 | 1.5 | 9.8 | | |
| | | C _L = 15 pF, R _L = 2kΩ | 1.5 ± 0.1 | 1.0 | 19.6 | | Figures 7, 9, 10 |
| t _{PLZ} | Output Disable Time | C _L = 30 pF, R _L = 500Ω | 3.3 ± 0.3 | 0.6 | 3.7 | ns | Figures 1, 3, 4 |
| t _{PHZ} | | | 2.5 ± 0.2 | 0.8 | 4.2 | | |
| | | | 1.8 ± 0.15 | 1.5 | 7.6 | | |
| | | C _L = 15 pF, R _L = 2kΩ | 1.5 ± 0.1 | 1.0 | 15.2 | | Figures 7, 9, 10 |

AC Electrical Characteristics (Continued)

| Symbol | Parameter | Conditions | V _{CC} (V) | T _A = -40°C to +85°C | | Units | Figure Number |
|----------------|-------------|---|------------------------|---------------------------------|-----|-------|------------------|
| | | | | Min | Max | | |
| t _S | Setup Time | C _L = 30 pF, R _L = 500Ω | 3.3 ± 0.3 | 1.5 | | ns | Figures 1, 6 |
| | | | 2.5 ± 0.2 | 1.5 | | | |
| | | C _L = 15 pF, R _L = 500Ω | 1.8 ± 0.15 | 2.5 | | | |
| | | C _L = 15 pF, R _L = 500Ω | 1.5 ± 0.1 | 3.0 | | | Figures 7, 8 |
| t _H | Hold Time | C _L = 30 pF, R _L = 500Ω | 3.3 ± 0.3 | 1.0 | | ns | Figures 1, 6 |
| | | | 2.5 ± 0.2 | 1.0 | | | |
| | | C _L = 15 pF, R _L = 500Ω | 1.8 ± 0.15 | 1.0 | | | |
| | | C _L = 15 pF, R _L = 500Ω | 1.5 ± 0.1 | 2.0 | | | Figures 7, 6 |
| t _W | Pulse Width | C _L = 30 pF, R _L = 500Ω | 3.3 ± 0.3 | 1.5 | | ns | Figures 1, 5 |
| | | | 2.5 ± 1.2 | 1.5 | | | |
| | | C _L = 15 pF, R _L = 500Ω | 1.8 ± 0.15 | 4.0 | | | |
| | | C _L = 15 pF, R _L = 500Ω | 1.5 ± 0.1 | 4.0 | | | Figures 5, 7 |

Note 11: For C_L = 50pF, add approximately 300ps to the AC maximum specification.

Dynamic Switching Characteristics

| Symbol | Parameter | Conditions | V _{CC} (V) | T _A = +25°C | Units |
|------------------|--|--|------------------------|------------------------|-------|
| | | | | Typical | |
| V _{OLP} | Quiet Output Dynamic Peak V _{OL} | C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V | 1.8 | 0.25 | V |
| | | | 2.5 | 0.6 | |
| | | | 3.3 | 0.8 | |
| V _{OLV} | Quiet Output Dynamic Valley V _{OL} | C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V | 1.8 | -0.25 | V |
| | | | 2.5 | -0.6 | |
| | | | 3.3 | -0.8 | |
| V _{OHV} | Quiet Output Dynamic Valley V _{OH} | C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V | 1.8 | 1.5 | V |
| | | | 2.5 | 1.9 | |
| | | | 3.3 | 2.2 | |

Capacitance

| Symbol | Parameter | Conditions | T _A = +25°C | Units |
|------------------|-------------------------------|---|------------------------|-------|
| C _{IN} | Input Capacitance | V _I = 0V or V _{CC} V _{CC} = 1.8V, 2.5V, or 3.3V, | 6.0 | pF |
| C _{I/O} | Output Capacitance | V _I = 0V, or V _{CC} , V _{CC} = 1.8V, 2.5V or 3.3V | 7.0 | pF |
| C _{PD} | Power Dissipation Capacitance | V _I = 0V or V _{CC} , f = 10 MHz V _{CC} = 1.8V, 2.5V or 3.3V | 20.0 | pF |

AC Loading and Waveforms (V_{CC} $3.3V \pm 0.3V$ to $1.8V \pm 0.15V$)

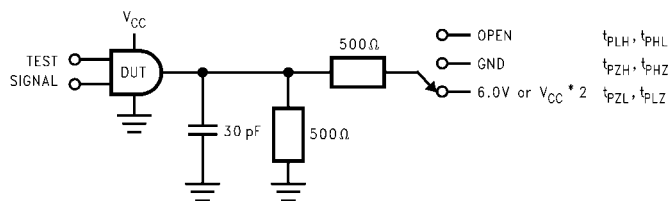


FIGURE 1. AC Test Circuit

| TEST | SWITCH |
|--------------------|--|
| t_{PLH}, t_{PHL} | Open |
| t_{PZL}, t_{PLZ} | 6V at $V_{CC} = 3.3 \pm 0.3V$; $V_{CC} \times 2$ at $V_{CC} = 2.5 \pm 0.2V; 1.8 \pm 0.15V$ |
| t_{PZH}, t_{PHZ} | GND |

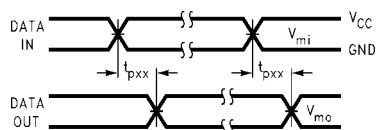


FIGURE 2. Waveform for Inverting and Non-inverting Functions

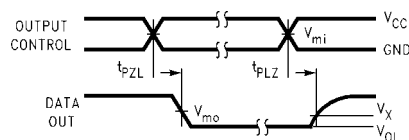


FIGURE 4. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

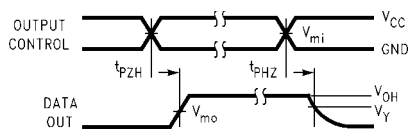


FIGURE 3. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

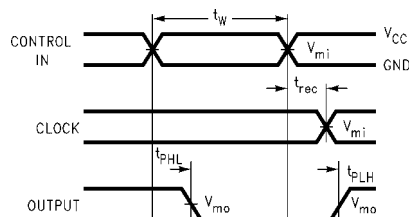


FIGURE 5. Propagation Delay, Pulse Width and t_{rec} Waveforms

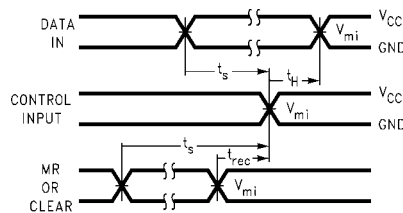
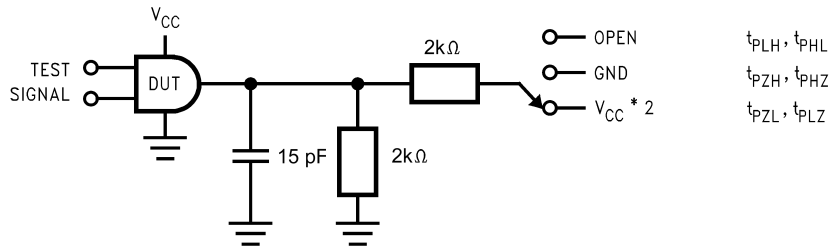


FIGURE 6. Setup Time, Hold Time and Recovery Time for Low Voltage Logic

| Symbol | V_{CC} | | |
|----------|-----------------|------------------|------------------|
| | $3.3V \pm 0.3V$ | $2.5V \pm 0.2V$ | $1.8 \pm 0.15V$ |
| V_{mi} | 1.5V | $V_{CC}/2$ | $V_{CC}/2$ |
| V_{mo} | 1.5V | $V_{CC}/2$ | $V_{CC}/2$ |
| V_X | $V_{OL} + 0.3V$ | $V_{OL} + 0.15V$ | $V_{OL} + 0.15V$ |
| V_Y | $V_{OH} - 0.3V$ | $V_{OH} - 0.15V$ | $V_{OH} - 0.15V$ |

AC Loading and Waveforms ($V_{CC} 1.5V \pm 0.1V$)



| TEST | SWITCH |
|--------------------|---|
| t_{PLH}, t_{PHL} | Open |
| t_{PZL}, t_{PLZ} | $V_{CC} \times 2$ at $V_{CC} = 1.5V \pm 0.1V$ |
| t_{PZH}, t_{PHZ} | GND |

FIGURE 7. AC Test Circuit

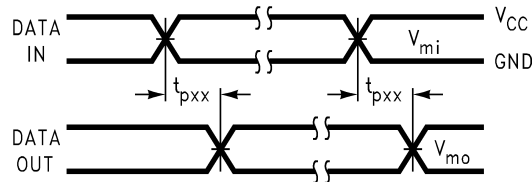


FIGURE 8. Waveform for Inverting and Non-Inverting Functions

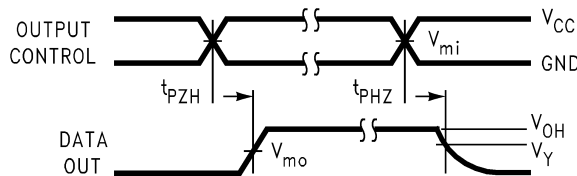


FIGURE 9. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

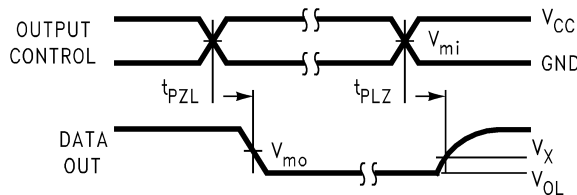
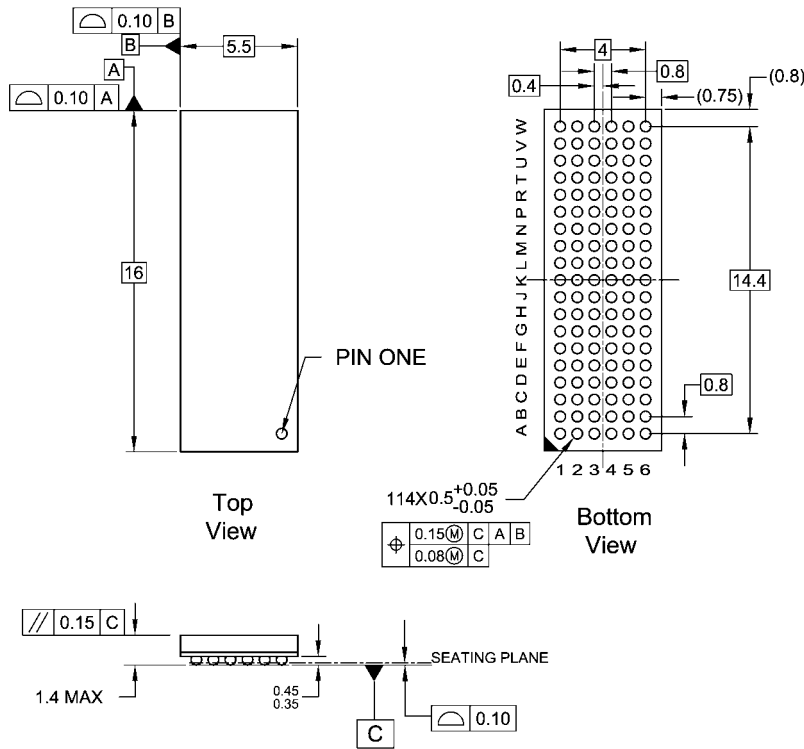


FIGURE 10. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

| Symbol | V_{CC} |
|----------|-----------------|
| | $1.5V \pm 0.1V$ |
| V_{mi} | $V_{CC}/2$ |
| V_{mo} | $V_{CC}/2$ |
| V_x | $V_{OL} + 0.1V$ |
| V_y | $V_{OH} - 0.1V$ |

Physical Dimensions inches (millimeters) unless otherwise noted



- NOTES:
- A. THIS PACKAGE CONFORMS TO JEDEC MO-205
 - B. ALL DIMENSIONS IN MILLIMETERS
 - C. LAND PATTERN RECOMMENDATION: NSMD (Non Solder Mask Defined)
.35MM DIA PADS WITH A SOLDERMASK OPENING OF .45MM CONCENTRIC TO PADS
 - D. DRAWING CONFORMS TO ASME Y14.5M-1994

BGA114ArevE

**114-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
Package Number BGA114A**

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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